TLW-1XX-XX-XXX-X-XX-XXX

No of positions: -01 thru -40 (single)
-01 thru -36 (double)

LEAD STYLE:
-01: RA (see fig 3, sht 2)
-05: TH (see table 1)
-06: TH (see table 1)

PLATING SPECIFICATION:
-G: Gold (specify -G in terminal suffix -XXX)
-T: Tin (specify -T in terminal suffix -XXX)
-H: Heavy gold (specify -H in terminal suffix -XXX)
-S: Selective (specify -S in terminal suffix -XXX)
-L: Light selective (specify -L in terminal suffix -XXX)
-M: Matte tin (specify -M in terminal suffix -XXX)
-SM: Selective heavy gold, matte tin tail (specify -S in terminal suffix -XXX)
-LM: Light selective gold, matte tin tail (specify -L in terminal suffix -XXX)
-STL: Selective gold, tin/lead tail (specify -STL in terminal suffix -XXX)

ROW SPECIFICATION:
-S: Single row (use TLW-XX-S)
-D: Double row (use TLW-XX-D)

OPTIONS:
-RA: Right angle (lead style -01 only)
-LL: TH with locking leads (see fig 6, sht 2)
-LA: RA with locking leads (see fig 4, sht 2)

Notes:
1. ◊ Represents a critical dimension.
3. Minimum terminal pushout force for -06 lead style: 1 lb.
4. All other lead styles: 2 lbs.
6. Maximum cut flash: .010 [0.25].
7. Orientate pins to prevent bandolier marks from showing in the post area. (see table 2, sht 3)

Table 1

<table>
<thead>
<tr>
<th>LEAD STYLE</th>
<th>TERMINAL 1</th>
<th>TERMINAL 2</th>
<th>&quot;L&quot;</th>
<th>&quot;A&quot;</th>
<th>&quot;B&quot;</th>
<th>&quot;C&quot;</th>
</tr>
</thead>
</table>

Material:
- Do not scale drawing
- Sheet scale: 4:1

Description:
Low profile terminal assembly

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### Table 2: (-T Plating Only)

<table>
<thead>
<tr>
<th>Lead Style</th>
<th>Terminal 1</th>
<th>Terminal 2</th>
</tr>
</thead>
<tbody>
<tr>
<td>* -05</td>
<td>0</td>
<td>N/A</td>
</tr>
<tr>
<td>-06</td>
<td>1</td>
<td>N/A</td>
</tr>
<tr>
<td>-01-S</td>
<td>0</td>
<td>N/A</td>
</tr>
<tr>
<td>-01-D</td>
<td>0</td>
<td>0</td>
</tr>
</tbody>
</table>

* Pins to be flipped opposite of the selective plating before being inserted.